region

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a third doped region formed in said second doped active layer beneath said isolation

- 16. (Amended) The diode according to claim 1, further comprising a fourth doped active layer at least partially within said first doped active layer.
- 17. (Amended) The diode according to claim 16, wherein said fourth doped active layer is spaced away from the edge of said first doped active layer.
- 18. (Amended) The diode according to claim 16, wherein said fourth doped active layer is an n-type region.
- 19. (Amended) The diode according to claim 16, wherein said fourth doped active layer is doped at a dopant dose of from about  $1 \times 10^{12}$  ions/cm<sup>2</sup> to about  $1 \times 10^{16}$  ions/cm<sup>2</sup>.
- 20. (Amended) The diode according to claim 9, further comprising a fourth doped active layer at least partially within said first doped active layer.
- 21. (Amended) The diode according to claim 20, wherein said fourth doped active layer is spaced away from the edge of said first doped active layer.
- 22. (Amended) The diode according to claim 20, wherein said fourth doped active layer is an n-type region.
- 23. (Amended) The diode according to claim 20, wherein said fourth doped active layer is doped at a dopant dose of from about 1x10<sup>12</sup> ions/cm<sup>2</sup> to about 1x10<sup>16</sup> ions/cm<sup>2</sup>
  - 28. (Amended) A diode for use in an imaging device, said diode comprising: an isolation region formed in a substrate;

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a first doped active layer of a first conductivity type formed in said substrate, said substrate being of a second conductivity type, wherein said first doped active layer is spaced apart from said isolation region;

a second doped active layer of said first conductivity type formed within said first doped active layer, wherein said second doped active layer is doped to a higher dopant dose than said first doped active layer, wherein said first active layer and said substrate form a p-n junction; and

a third doped region proximate to a lower boundary of said isolation region.

- 50. (Amended) An imager device comprising:
- (i) a processor; and
- (ii) an imaging device coupled to said processor, said imaging device comprising:

  a photodiode for use in said imaging device, said photodiode comprising:

  an isolation region formed in a substrate;

a first doped photoactive layer of a first conductivity type formed in said substrate, wherein said first doped layer is spaced apart from said isolation region;

a second doped photoactive layer of a second conductivity type disposed in contact with said first doped photoactive layer, the contact of said first and second photoactive layers forming a p-n junction; and

a third doped region formed in said second doped photoactive layer beneath said isolation region.

- 67. (Amended) An imager device comprising:
- (i) a processor; and
- (ii) an imaging device coupled to said processor, said imaging device comprising:

  a photodiode for use in an imaging device, said photodiode comprising:

  an isolation region formed in a substrate;

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a first doped photoactive layer of a first conductivity type formed in said substrate, said substrate being doped to a second conductivity type, wherein said first doped photoactive layer is spaced apart from said isolation region;

a second doped photoactive layer of said first conductivity type formed within said first doped photoactive layer, wherein said second doped photoactive layer is doped to a higher dopant dose than said first doped photoactive layer, wherein said first photoactive layer and said substrate form a p-n junction; and

a third doped region formed in said substrate beneath said isolation region and spaced apart from said first photoactive layer.